

## Part Number: ZCBD53W-1

1.6X0.8mm SMD CHIP LED LAMP

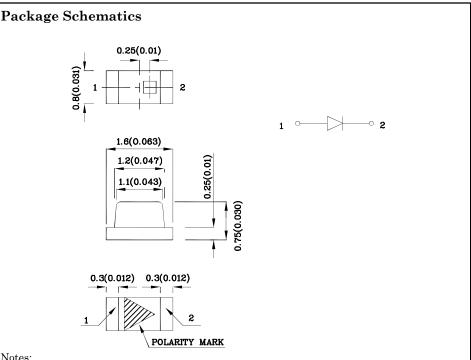
### Features

- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 2,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- $\bullet$  RoHS compliant





ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES



Notes: 1. All dimensions are in millimeters (inches).

2. Tolerance is  $\pm 0.1(0.004")$  unless otherwise noted.

3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)		CBD (InGaN)	Unit	
Reverse Voltage		5	V	
Forward Current	$\mathbf{I}_{\mathrm{F}}$	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	150	mA	
Power Dissipation	PD	120	mW	
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	$-40 \sim +85$	-0	
Electrostatic Discharge Threshold (HBM)	250	V		

Operating Characteristics (T <sub>A</sub> =25°C)	CBD (InGaN)	Unit	
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\rm F}$	3.3	V
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\rm F}$	4	V
Reverse Current (Max.) (V <sub>R</sub> =5V)	$I_R$	50	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)	λP	460*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)	λD	465*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	$ riangle\lambda$	25	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	100	$_{\rm pF}$

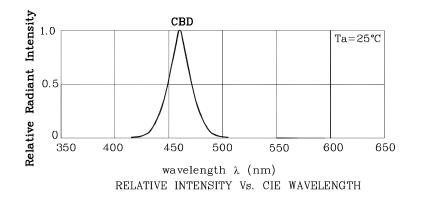
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (I <sub>F</sub> =20mA) mcd		Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
				min.	typ.		
ZCBD53W-1	Blue	InGaN	Water Clear	40*	98*	460*	120°

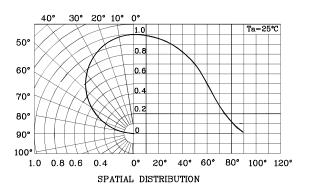
 ${\rm *Luminous\ intensity\ value\ and\ wavelength\ are\ in\ accordance\ with\ CIE127-2007\ standards.}$ 

Feb 27,2014

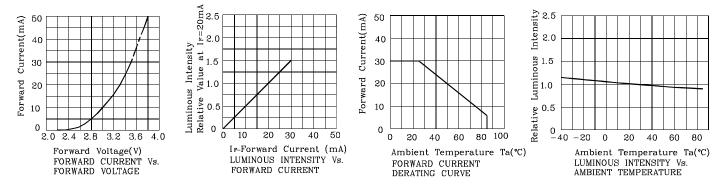
SDSA6689 V4-Z Layout: Maggie L.



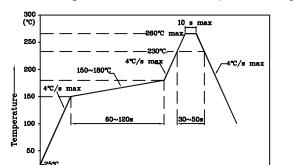




#### ♦ CBD



# LED is recommended for reflow soldering and soldering profile is shown below.



Reflow Soldering Profile for SMD Products (Pb-Free Components)

1. Maximum soldering temperature should not exceed 260°C

150

200

250

300 (sec)

2. Recommended reflow temperature: 145°C-260°C 3. Do not put stress to the epoxy resin during

Time

high temperatures conditions

100

50

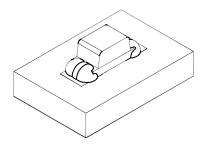
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Notes:

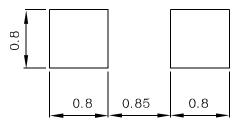
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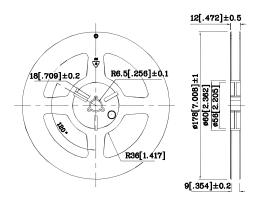
✤ The device has a single mounting surface. The device must be mounted according to the specifications.



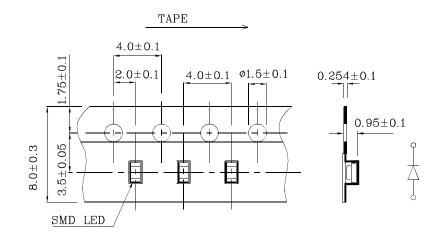
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension



# Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

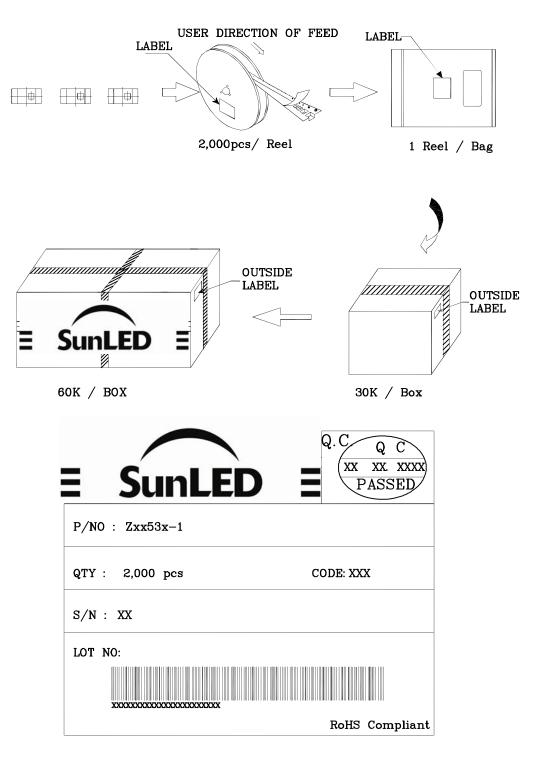
2. Luminous intensity / luminous flux: +/-15%

3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.



## **PACKING & LABEL SPECIFICATIONS**



### TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet.
- User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
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